TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOSIII)

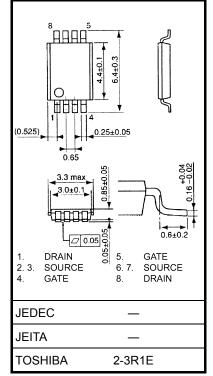
TPCS8208

Lithium Ion Battery Applications

- Small footprint due to small and thin package
- Low drain-source ON resistance: R_{DS} (ON) = 13 m Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 15 \text{ S (typ.)}$
- Low leakage current: $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 20 \ V)$
- Enhancement mode: $V_{th} = 0.5 \sim 1.2 \text{ V} (V_{DS} = 10 \text{ V}, I_D = 200 \text{ }\mu\text{A})$
- Common drain

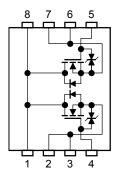
Absolute Maximum Ratings (Ta = 25°C)

| Char | acteristics | Symbol | Rating | Unit | |
|---|--|--------------------|---------------------|------|--|
| Drain-source voltage | | V _{DSS} | 20 | V | |
| Drain-gate voltag | ge (R _{GS} = 20 kΩ) | V _{DGR} | 20 | V | |
| Gate-source volt | age | V _{GSS} | ±12 | V | |
| Drain current | DC (Note 1) | I _D | 6 | А | |
| Drain current | Pulse (Note 1) | I _{DP} | 24 | A | |
| Drain power | Single-device operation (Note 3a) | P _{D (1)} | 1.1 | W | |
| dissipation (t = 10 s) (Note 2a) | Single-device value at dual operation (Note 3b) | P _{D (2)} | 0.75 | | |
| Drain power dissipation (t = 10 s) (Note 2b) | Single-device operation (Note 3a) | P _{D (1)} | 0.6 | W | |
| | Single-device value at dual operation (Note 3b) | P _{D (2)} | 0.35 | | |
| Single pulse avalanche energy (Note 4) | | E _{AS} | 46.8 | mJ | |
| Avalanche currei | nt | I _{AR} | 6 | А | |
| Repetitive avalar Single-device va | nche energy lue at dual operation (Note 2a, 3b, 5) | E _{AR} | 0.075 | mJ | |
| Channel tempera | I temperature | | T _{ch} 150 | | |
| Storage tempera | ture range | T _{stg} | -55~150 | °C | |



Weight: 0.035 g (typ.)

Circuit Configuration



Note: (Note 1), (Note 2), (Note 3), (Note 4), (Note 5): See the next page.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

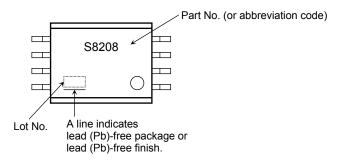
This transistor is an electrostatic-sensitive device. Please handle with caution.

Unit: mm

Thermal Characteristics

| Characteristics | Symbol | Max | Unit | | |
|--|---|----------------------------|------|------|--|
| The median state of the median | Single-device operation (Note 3a) | R _{th (ch-a) (1)} | 114 | °C/W | |
| Thermal resistance, channel to ambient (t = 10 s) (Note 2a) | Single-device value at dual operation (Note 3b) | R _{th (ch-a) (2)} | 167 | | |
| Thermal resistance, channel to ambient | Single-device operation (Note 3a) | R _{th (ch-a) (1)} | 208 | | |
| (t = 10 s) (Note 2b) | Single-device value at dual operation (Note 3b) | R _{th (ch-a) (2)} | 357 | °C/W | |

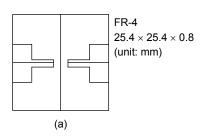
Marking (Note 6)



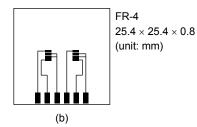


Note 2:

a) Device mounted on a glass-epoxy board (a)

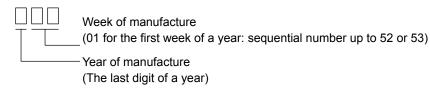


b) Device mounted on a glass-epoxy board (b)



Note 3:

- a) The power dissipation and thermal resistance values are shown for a single device (During single-device operation, power is only applied to one device.)
- b) The power dissipation and thermal resistance values are shown for a single device (During dual operation, power is evenly applied to both devices.)
- Note 4: $V_{DD} = 16 \text{ V}, \text{ T}_{ch} = 25^{\circ}\text{C}$ (initial), L = 1.0 mH, R_G = 25 Ω , I_{AR} = 6 A
- Note 5: Repetitive rating: pulse width limited by maximum channel temperature
- Note 6: \circ on lower right of the marking indicates Pin 1.
 - ※ Weekly code: (Three digits)



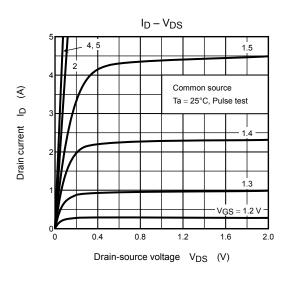
Electrical Characteristics (Ta = 25°C)

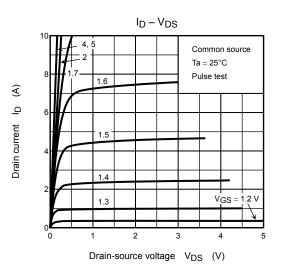
| Cha | aracteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|--|----------------|----------------------|--|--------|------|-----|------|
| Gate leakage cur | rent | I _{GSS} | $V_{GS}=\pm 10~V,~V_{DS}=0~V$ | _ | | ±10 | μA |
| Drain cut-OFF cu | rrent | I _{DSS} | $V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | — — 10 | | μA | |
| Drain-source brea | akdown voltago | V (BR) DSS | $I_{D} = 10 \text{ mA}, V_{GS} = 0 \text{ V}$ | 20 | _ | _ | V |
| Drain-source brea | akuown voltage | V (BR) DSX | $I_D = 10 \text{ mA}, V_{GS} = -12 \text{ V}$ | 8 | _ | _ | |
| Gate threshold ve | oltage | V _{th} | $V_{DS}=10~V,~I_D=200~\mu A$ | 0.5 | _ | 1.2 | V |
| | | | $V_{GS} = 2.0 \text{ V}, \text{ I}_{D} = 4.2 \text{ A}$ | _ | 24 | 35 | |
| Drain-source ON resistance | | R _{DS (ON)} | $V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 4.2 \text{ A}$ | _ | 18 | 22 | mΩ |
| | | | $V_{GS} = 4.0 \text{ V}, \text{ I}_{D} = 4.8 \text{ A}$ | _ | 13 | 17 | |
| Forward transfer admittance | | Y _{fs} | $V_{DS} = 10 \text{ V}, \text{ I}_{D} = 3.0 \text{ A}$ | 7.5 | 15 | _ | S |
| Input capacitance | | C _{iss} | V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz | _ | 2160 | _ | pF |
| Reverse transfer capacitance | | C _{rss} | | | 210 | | |
| Output capacitance | | C _{oss} | | _ | 230 | _ | |
| Switching time | Rise time | tr | $V_{GS} \begin{array}{c} 5 \\ 0 \\ V \end{array} \begin{array}{c} V_{GS} \\ 0 \\ V \end{array} \begin{array}{c} V \\ 0 \\ 0$ | _ | 5 | _ | ns |
| | Turn-ON time | t _{on} | | | 13 | | |
| | Fall time | t _f | | | 10 | | |
| | Turn-OFF time | t _{off} | | _ | 53 | | |
| Total gate charge (gate-source plus gate-drain) | | Qg | | _ | 22 | _ | |
| Gate-source charge 1 | | Q _{gs1} | $V_{DD} \simeq 16 \text{ V}, \text{ V}_{GS} = 5 \text{ V}, \text{ I}_{D} = 6 \text{ A}$ | _ | 4 | _ | nC |
| Gate-drain ("miller") charge | | Q _{gd} | | | 5 | | |

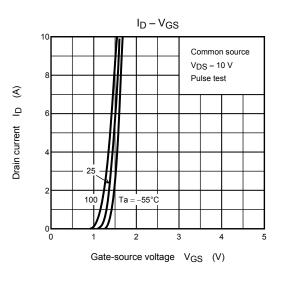
Source-Drain Ratings and Characteristics (Ta = 25°C)

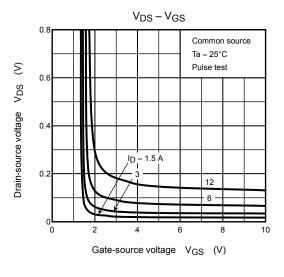
| Characteristics | | Symbol | Test Condition | Min | Тур. | Max | Unit |
|-------------------------|----------------|------------------|--|-----|------|------|------|
| Drain reverse current | Pulse (Note 1) | I _{DRP} | — | _ | _ | 24 | А |
| Forward voltage (diode) | | V _{DSF} | $I_{DR} = 6 \text{ A}, V_{GS} = 0 \text{ V}$ | _ | _ | -1.2 | V |

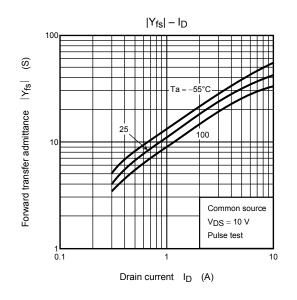
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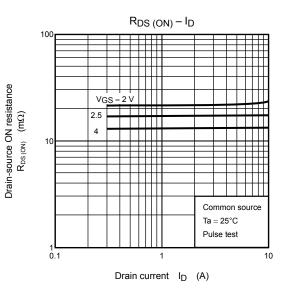




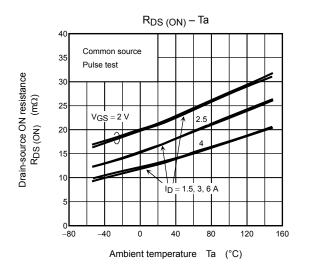


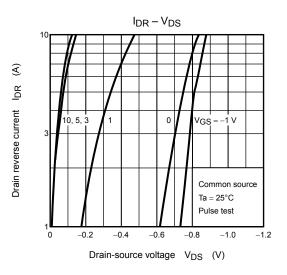


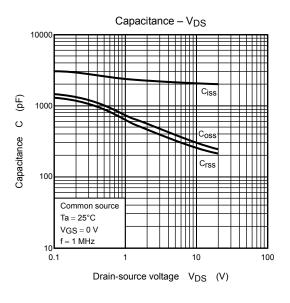


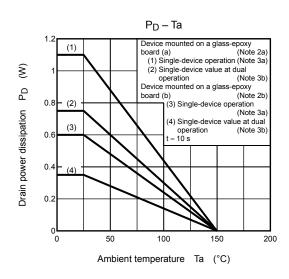


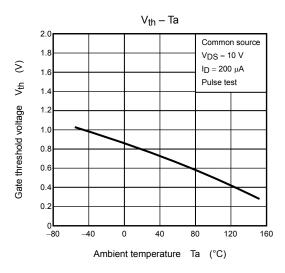
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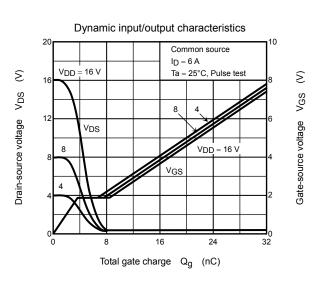








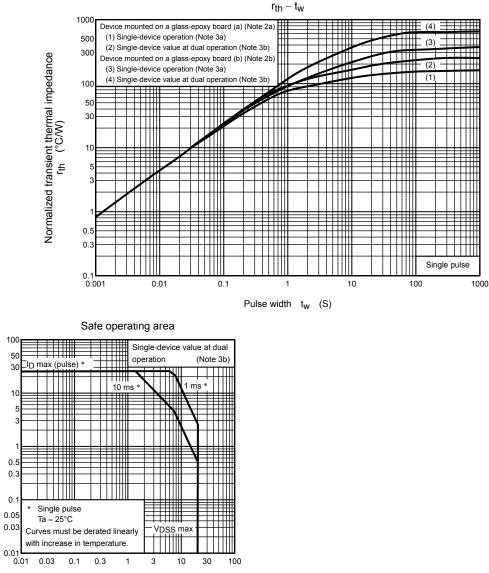




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Drain current



Drain-source voltage V_{DS} (V)

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